

# MC74HC377A

## Octal D Flip-Flop with Common Clock and Enable

### High-Performance Silicon-Gate CMOS

The MC74HC377A is identical in pinout to the LS273. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

This device consists of eight D flip-flops with common Clock and Enable ( $\bar{E}$ ) inputs. Each flip-flop is loaded with a low-to-high transition of the Clock input. Enable ( $\bar{E}$ ) is active low.

#### Features

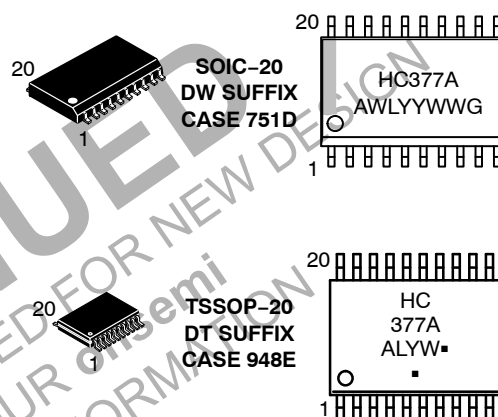
- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1.0  $\mu$ A
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- Chip Complexity: 264 FETs or 66 Equivalent Gates
- These are Pb-Free Devices



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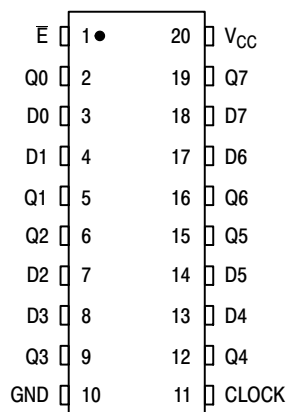
<http://onsemi.com>

#### MARKING DIAGRAMS



A = Assembly Location  
WL, L = Wafer Lot  
YY, Y = Year  
WW, W = Work Week  
G = Pb-Free Package  
▪ = Pb-Free Package  
(Note: Microdot may be in either location)

#### PIN ASSIGNMENT



#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

# MC74HC377A

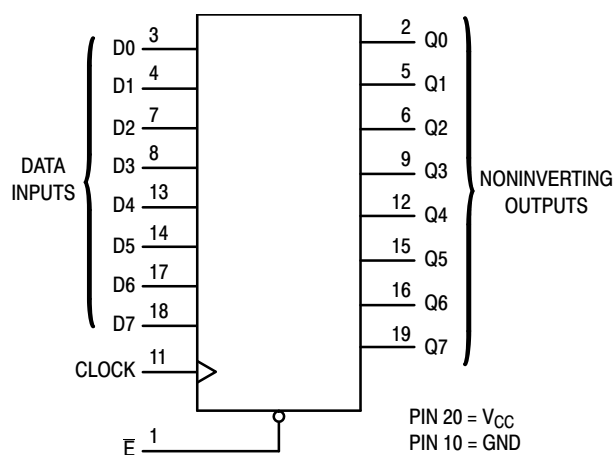


Figure 1. Logic Diagram

## FUNCTION TABLE

| Operating Modes   | Inputs |           |        | Outputs                |
|-------------------|--------|-----------|--------|------------------------|
|                   | Clock  | $\bar{E}$ | Dn     | Qn                     |
| Load "1"          | ↑      | L         | h      | H                      |
| Load "0"          | ↑      | L         | L      | L                      |
| Hold (Do Nothing) | ↑<br>X | h<br>H    | X<br>X | No Change<br>No Change |

H = HIGH voltage level

h = HIGH voltage level one setup time prior to the LOW-to-HIGH CP transition

L = LOW voltage level

L = LOW voltage level one setup time prior to the LOW-to-HIGH CP transition

↑ = LOW-to-HIGH CP transition

X = Don't Care

| Design Criteria                 | Value | Units |
|---------------------------------|-------|-------|
| Internal Gate Count*            | 66    | ea    |
| Internal Gate Propagation Delay | 1.5   | ns    |
| Internal Gate Power Dissipation | 5.0   | μW    |
| Speed Power Product             | .0075 | pJ    |

\*Equivalent to a two-input NAND gate.

## ORDERING INFORMATION

| Device          | Package                | Shipping†        |
|-----------------|------------------------|------------------|
| MC74HC377ADWG   | SOIC-20 WIDE (Pb-Free) | 38 Units / Rail  |
| MC74HC377ADWR2G | SOIC-20 WIDE (Pb-Free) | 1000 Tape & Reel |
| MC74HC377ADTG   | TSSOP-20*              | 75 Units / Rail  |
| MC74HC377ADTR2G | TSSOP-20*              | 2500 Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*This package is inherently Pb-Free.

# MC74HC377A

## MAXIMUM RATINGS

| Symbol    | Parameter                                                         | Value                  | Unit |
|-----------|-------------------------------------------------------------------|------------------------|------|
| $V_{CC}$  | DC Supply Voltage (Referenced to GND)                             | -0.5 to +7.0           | V    |
| $V_{in}$  | DC Input Voltage (Referenced to GND)                              | -0.5 to $V_{CC} + 0.5$ | V    |
| $V_{out}$ | DC Output Voltage (Referenced to GND)                             | -0.5 to $V_{CC} + 0.5$ | V    |
| $I_{in}$  | DC Input Current, per Pin                                         | $\pm 20$               | mA   |
| $I_{out}$ | DC Output Current, per Pin                                        | $\pm 25$               | mA   |
| $I_{CC}$  | DC Supply Current, $V_{CC}$ and GND Pins                          | $\pm 50$               | mA   |
| $P_D$     | Power Dissipation in Still Air<br>SOIC Package†<br>TSSOP Package† | 500<br>450             | mW   |
| $T_{stg}$ | Storage Temperature                                               | -65 to +150            | °C   |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

†Derating - SOIC Package: - 7 mW/°C from 65° to 125°C  
TSSOP Package: - 6.1 mW/°C from 65° to 125°C

## RECOMMENDED OPERATING CONDITIONS

| Symbol                             | Parameter                                            | Min                                                                                          | Max                | Unit |
|------------------------------------|------------------------------------------------------|----------------------------------------------------------------------------------------------|--------------------|------|
| V <sub>CC</sub>                    | DC Supply Voltage (Referenced to GND)                | 2.0                                                                                          | 6.0                | V    |
| V <sub>in</sub> , V <sub>out</sub> | DC Input Voltage, Output Voltage (Referenced to GND) | 0                                                                                            | V <sub>CC</sub>    | V    |
| T <sub>A</sub>                     | Operating Temperature, All Package Types             | −55                                                                                          | +125               | °C   |
| t <sub>r</sub> , t <sub>f</sub>    | Input Rise and Fall Time<br>(Figure 2)               | V <sub>CC</sub> = 2.0 V<br>0<br>V <sub>CC</sub> = 4.5 V<br>0<br>V <sub>CC</sub> = 6.0 V<br>0 | 1000<br>500<br>400 | ns   |

# MC74HC377A

## DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol          | Parameter                                      | Test Conditions                                                                                   | V <sub>CC</sub><br>V | Guaranteed Limit |              |            | Unit |
|-----------------|------------------------------------------------|---------------------------------------------------------------------------------------------------|----------------------|------------------|--------------|------------|------|
|                 |                                                |                                                                                                   |                      | -55 to<br>25°C   | ≤ 85°C       | ≤ 125°C    |      |
| V <sub>IH</sub> | Minimum High-Level Input Voltage               | V <sub>out</sub> = V <sub>CC</sub> - 0.1 V<br> I <sub>out</sub>   ≤ 20 μA                         | 2.0                  | 1.5              | 1.5          | 1.5        | V    |
|                 |                                                |                                                                                                   | 3.0                  | 2.1              | 2.1          | 2.1        |      |
|                 |                                                |                                                                                                   | 4.5                  | 3.15             | 3.15         | 3.15       |      |
|                 |                                                |                                                                                                   | 6.0                  | 4.2              | 4.2          | 4.2        |      |
| V <sub>IL</sub> | Maximum Low-Level Input Voltage                | V <sub>out</sub> = 0.1 V<br> I <sub>out</sub>   ≤ 20 μA                                           | 2.0                  | 0.5              | 0.5          | 0.5        | V    |
|                 |                                                |                                                                                                   | 3.0                  | 0.9              | 0.9          | 0.9        |      |
|                 |                                                |                                                                                                   | 4.5                  | 1.35             | 1.35         | 1.35       |      |
|                 |                                                |                                                                                                   | 6.0                  | 1.8              | 1.8          | 1.8        |      |
| V <sub>OH</sub> | Minimum High-Level Output Voltage              | V <sub>in</sub> = V <sub>IH</sub><br> I <sub>out</sub>   ≤ 20 μA                                  | 2.0                  | 1.9              | 1.9          | 1.9        | V    |
|                 |                                                |                                                                                                   | 4.5                  | 4.4              | 4.4          | 4.4        |      |
|                 |                                                |                                                                                                   | 6.0                  | 5.9              | 5.9          | 5.9        |      |
|                 |                                                | V <sub>in</sub> = V <sub>IH</sub><br> I <sub>out</sub>   ≤ 4.0 mA<br> I <sub>out</sub>   ≤ 5.2 mA | 4.5<br>6.0           | 3.98<br>5.48     | 3.84<br>5.34 | 3.7<br>5.2 |      |
| V <sub>OL</sub> | Maximum Low-Level Output Voltage               | V <sub>in</sub> = V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20 μA                                  | 2.0                  | 0.1              | 0.1          | 0.1        | V    |
|                 |                                                |                                                                                                   | 4.5                  | 0.1              | 0.1          | 0.1        |      |
|                 |                                                |                                                                                                   | 6.0                  | 0.1              | 0.1          | 0.1        |      |
|                 |                                                | V <sub>in</sub> = V <sub>IL</sub><br> I <sub>out</sub>   ≤ 4.0 mA<br> I <sub>out</sub>   ≤ 5.2 mA | 4.5<br>6.0           | 0.26<br>0.26     | 0.33<br>0.33 | 0.4<br>0.4 |      |
| I <sub>in</sub> | Maximum Input Leakage Current                  | V <sub>in</sub> = V <sub>CC</sub> or GND                                                          | 6.0                  | ±0.1             | ±1.0         | ±1.0       | μA   |
| I <sub>CC</sub> | Maximum Quiescent Supply Current (per Package) | V <sub>in</sub> = V <sub>CC</sub> or GND<br>I <sub>out</sub> = 0 μA                               | 6.0                  | 4.0              | 40           | 160        | μA   |

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# MC74HC377A

## AC Electrical Characteristics ( $C_L = 50 \text{ pF}$ , Input $t_r, t_f = 6.0 \text{ ns}$ )

| Symbol             | Parameter                                         | Test Conditions | $V_{CC} \text{ (V)}$ | Guaranteed Limits                |                         |                          | Unit |
|--------------------|---------------------------------------------------|-----------------|----------------------|----------------------------------|-------------------------|--------------------------|------|
|                    |                                                   |                 |                      | $-55^\circ\text{C to } 25^\circ$ | $\leq 85^\circ\text{C}$ | $\leq 125^\circ\text{C}$ |      |
| $t_{PHL}, t_{PLH}$ | Maximum Propagation Delay<br>Clock to $Q_n$       | Figures 2, 4    | 2.0                  | 160                              | 200                     | 240                      | ns   |
|                    |                                                   |                 | 4.5                  | 32                               | 40                      | 48                       |      |
|                    |                                                   |                 | 6.0                  | 27                               | 34                      | 41                       |      |
| $t_{THL}, t_{TLH}$ | Maximum Output Transition<br>Time                 | Figures 2, 4    | 2.0                  | 75                               | 95                      | 110                      | ns   |
|                    |                                                   |                 | 4.5                  | 15                               | 19                      | 22                       |      |
|                    |                                                   |                 | 6.0                  | 13                               | 16                      | 19                       |      |
| $t_W$              | Minimum Clock Pulse Width<br>High or Low          | Figure 2        | 2.0                  | 80                               | 100                     | 120                      | ns   |
|                    |                                                   |                 | 4.5                  | 16                               | 20                      | 24                       |      |
|                    |                                                   |                 | 6.0                  | 4                                | 17                      | 20                       |      |
| $t_{su}$           | Minimum Set-up Time<br>$D_n$ to Clock             | Figure 3        | 2.0                  | 60                               | 75                      | 90                       | ns   |
|                    |                                                   |                 | 4.5                  | 12                               | 15                      | 18                       |      |
|                    |                                                   |                 | 6.0                  | 10                               | 13                      | 15                       |      |
| $t_{su}$           | Minimum Set-up Time<br>Enable to Clock            | Figure 3        | 2.0                  | 60                               | 75                      | 90                       | ns   |
|                    |                                                   |                 | 4.5                  | 12                               | 15                      | 18                       |      |
|                    |                                                   |                 | 6.0                  | 10                               | 13                      | 15                       |      |
| $t_h$              | Minimum Hold Time<br>$D_n$ to Clock               | Figure 3        | 2.0                  | 3                                | 3                       | 3                        | ns   |
|                    |                                                   |                 | 4.5                  | 3                                | 3                       | 3                        |      |
|                    |                                                   |                 | 6.0                  | 3                                | 3                       | 3                        |      |
| $t_h$              | Minimum Hold Time<br>Enable to Clock              | Figure 3        | 2.0                  | 4                                | 4                       | 4                        | ns   |
|                    |                                                   |                 | 4.5                  | 4                                | 4                       | 4                        |      |
|                    |                                                   |                 | 6.0                  | 4                                | 4                       | 4                        |      |
| $f_{max}$          | Maximum Clock Pulse<br>Frequency (50% duty cycle) | Figures 2, 4    | 2.0                  | 6                                | 5                       | 4                        | ns   |
|                    |                                                   |                 | 4.5                  | 30                               | 24                      | 20                       |      |
|                    |                                                   |                 | 6.0                  | 35                               | 28                      | 24                       |      |
| $C_{in}$           | Maximum Input Capacitance                         |                 | –                    | 10                               | 10                      | 10                       | pF   |

|                      |                               |                                                      |    |
|----------------------|-------------------------------|------------------------------------------------------|----|
| $C_{PD}$<br>(Note 1) |                               | Typical @ $25^\circ\text{C}, V_{CC} = 5.0 \text{ V}$ | pF |
|                      | Power Dissipation Capacitance | 35                                                   |    |

1.  $C_{PD}$  is defined as the value of the IC's equivalent capacitance from which the operating current can be calculated from:  
 $I_{CC}(\text{operating}) \approx C_{PD} \times V_{CC} \times f_{IN} \times N_{SW}$  where  $N_{SW}$  = total number of outputs switching and  $f_{IN}$  = switching frequency.

# MC74HC377A

## SWITCHING WAVEFORMS

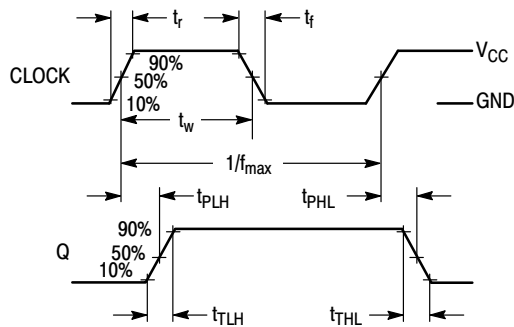


Figure 2.

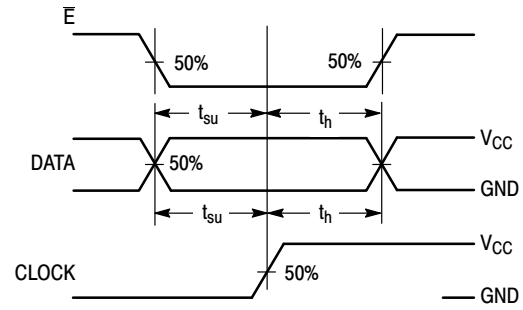
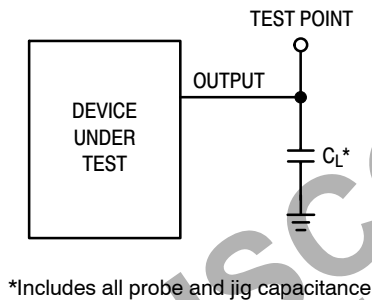


Figure 3.



\*Includes all probe and jig capacitance

Figure 4. Test Circuit

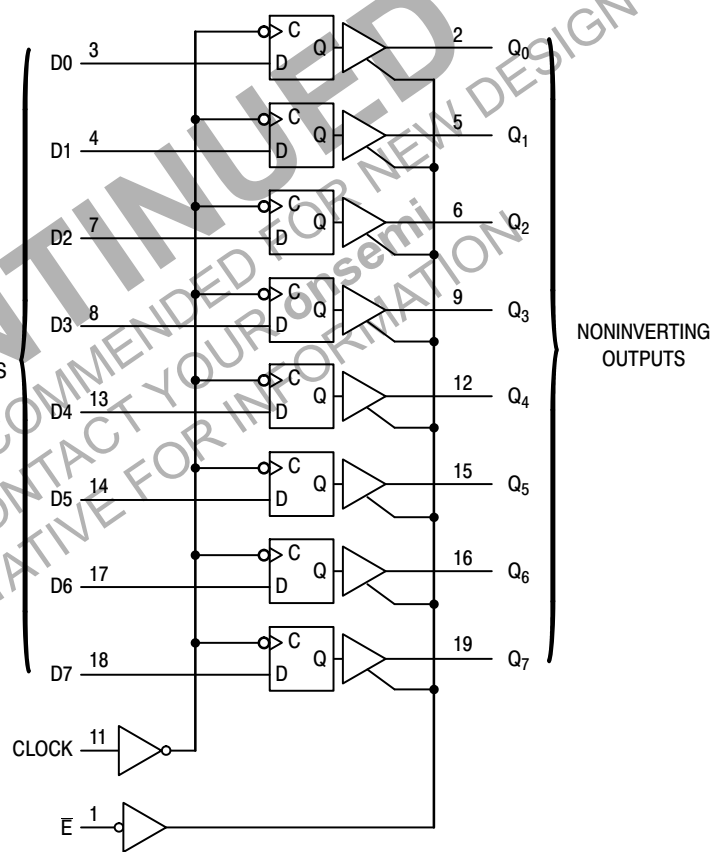
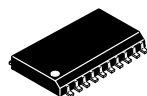


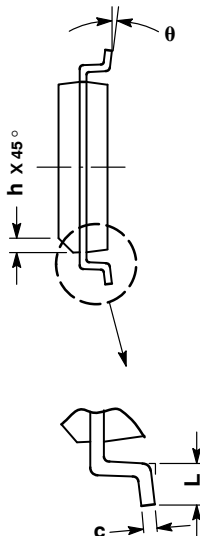
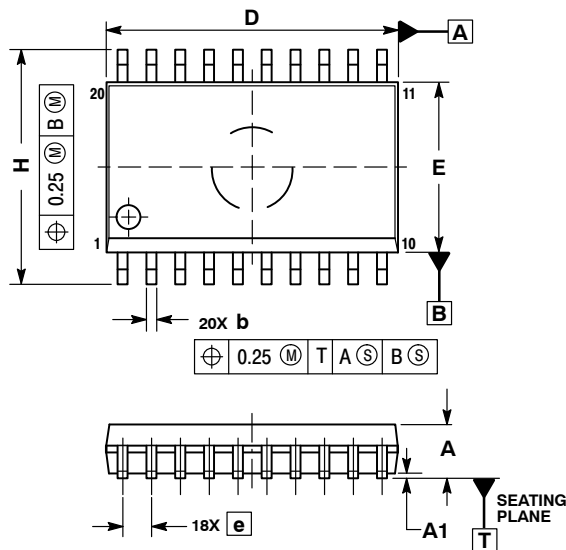
Figure 5. Expanded Logic Diagram



SCALE 1:1

SOIC-20 WB  
CASE 751D-05  
ISSUE H

DATE 22 APR 2015

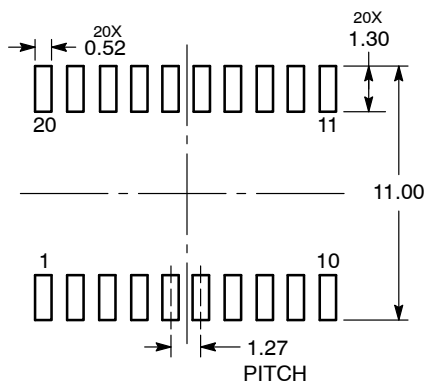


NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS |       |
|-----|-------------|-------|
|     | MIN         | MAX   |
| A   | 2.35        | 2.65  |
| A1  | 0.10        | 0.25  |
| b   | 0.35        | 0.49  |
| c   | 0.23        | 0.32  |
| D   | 12.65       | 12.95 |
| E   | 7.40        | 7.60  |
| e   | 1.27 BSC    |       |
| H   | 10.05       | 10.55 |
| h   | 0.25        | 0.75  |
| L   | 0.50        | 0.90  |
| θ   | 0°          | 7°    |

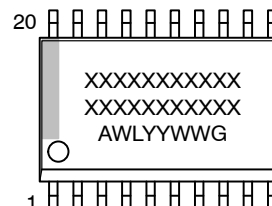
RECOMMENDED  
SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC  
MARKING DIAGRAM\*

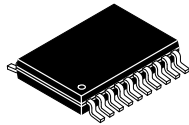


XXXXXX = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week  
G = Pb-Free Package

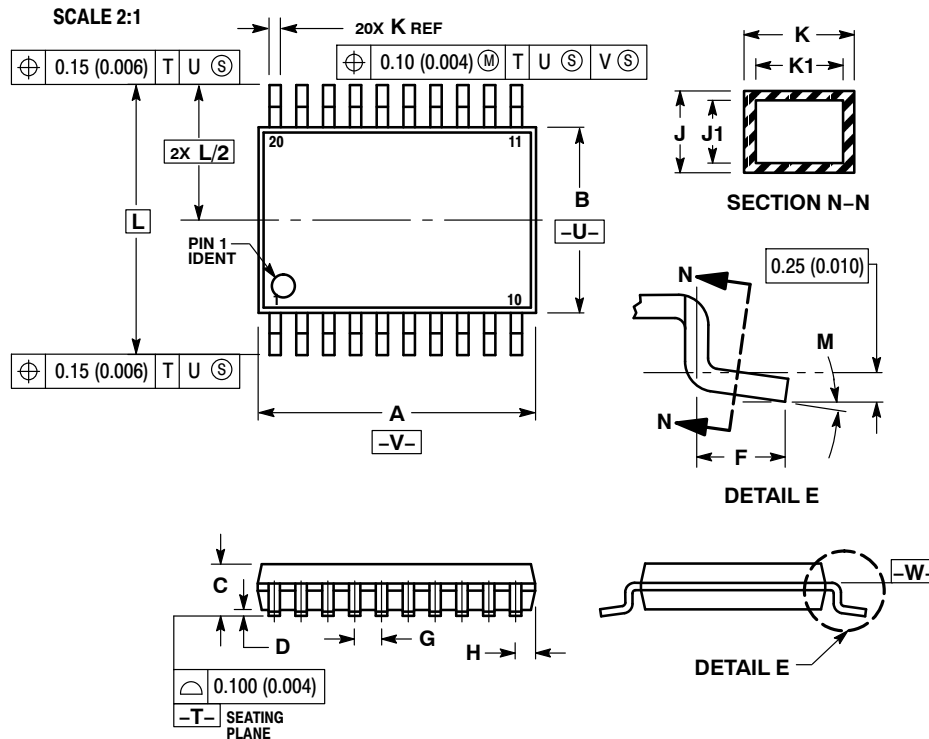
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

|                  |             |                                                                                                                                                                                     |
|------------------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
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| DESCRIPTION:     | SOIC-20 WB  | PAGE 1 OF 1                                                                                                                                                                         |

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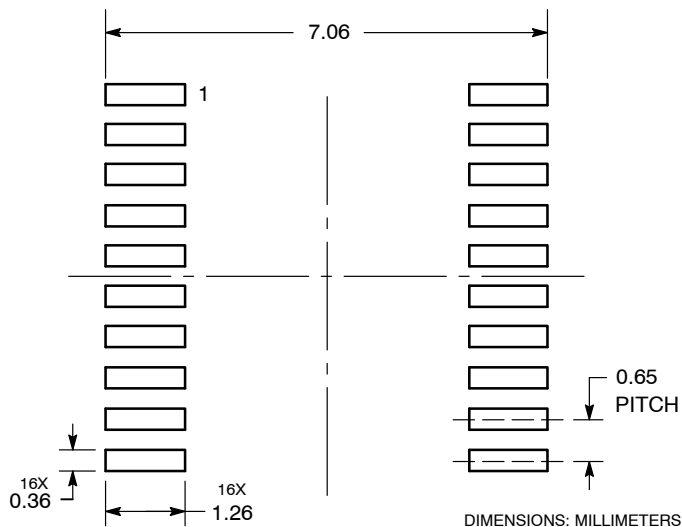

**TSSOP-20 WB**  
**CASE 948E**  
**ISSUE D**

DATE 17 FEB 2016

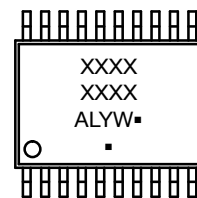

**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 6.40        | 6.60 | 0.252     | 0.260 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | ---         | 1.20 | ---       | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.27        | 0.37 | 0.011     | 0.015 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |

**RECOMMENDED  
SOLDERING FOOTPRINT\***


\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

**GENERIC  
MARKING DIAGRAM\***


A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

|                         |                    |                                                                                                                                                                                     |
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